

# CAT3612

## Programmable 300 mA Camera Flash LED Driver

### Description

The CAT3612 is a high-efficiency 1x/1.5x fractional charge pump with programmable current in two LED channels. Each channel delivers accurate regulated current up to 150 mA and make CAT3612 ideal for driving one or two flash LEDs.

Low noise operation is achieved by operating at a constant switching frequency of 1 MHz which allows the use of small external ceramic capacitors. The 1x/1.5x fractional charge pump supports a wide range of input voltages from 3 V to 5.5 V with efficiency up to 90%, and is ideal for Li-Ion battery powered devices.

The EN/DIM logic input provides a 1-wire EZDim™ interface for dimming control of the LEDs. When enabled, pulsing the EN/DIM reduces the LED current on each negative edge in 31 linear steps from 150 mA down to zero current.

The device is available in the tiny 12-lead thin DFN 3 mm x 3 mm package with a max height of 0.8 mm.

### Features

- Dual Matched Regulated LED Channels
- 300 mA Output Current (150 mA per Channel)
- 1-wire EZDim™ Programmable LED Current
- 32 Accurate Dimming Levels
- Power Efficiency up to 90%
- Fractional Pump 1x/1.5x
- Low Noise Input Ripple
- Fixed High Frequency Operation 1 MHz
- “Zero” Current Shutdown Mode
- Soft Start and Current Limiting
- Short Circuit Protection
- Thermal Shutdown Protection
- 12-lead TDFN 3 mm x 3 mm Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Applications

- Camera Flash
- Cellular Phones
- Digital Still Cameras



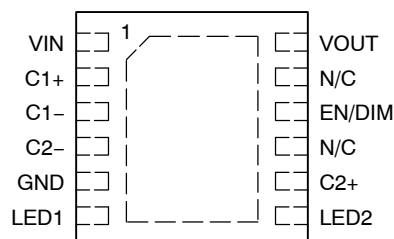
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TDFN-12  
HV2 SUFFIX  
CASE 511AN

### PIN CONNECTIONS



(Top View)

### MARKING DIAGRAM



HAAD = CAT3612HV2-T2

HAAF = CAT3612HV2-GT2

A = Assembly Location

XXX = Last Three Digits of Assembly Lot Number

Y = Production Year (Last Digit)

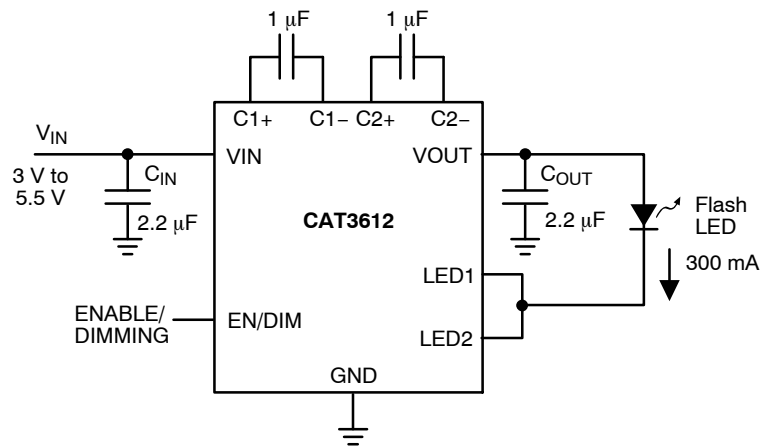
WW = Production Week (Two Digit)

### ORDERING INFORMATION

Device	Package	Shipping
CAT3612HV2-T2 (Note 1)	TDFN-12 (Pb-Free)	2,000/ Tape & Reel
CAT3612HV2-GT2 (Note 2)	TDFN-12 (Pb-Free)	2,000/ Tape & Reel

1. Matte-Tin Plated Finish (RoHS-compliant).
2. NiPdAu Plated Finish (RoHS-compliant).

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**Figure 1. Typical Application Circuit**

NOTE: Unused LED channel must be connected to VOUT

**Table 1. ABSOLUTE MAXIMUM RATINGS**

Parameter	Rating	Unit
VIN, LED1, LED2 voltage	6	V
VOUT, C1±, C2± voltage	7	V
EN/DIM voltage	VIN + 0.7 V	V
Storage Temperature Range	-65 to +160	°C
Junction Temperature Range	-40 to +150	°C
Lead Temperature	300	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

**Table 2. RECOMMENDED OPERATING CONDITIONS**

Parameter	Range	Unit
VIN	3 to 5.5	V
Ambient Temperature Range	-40 to +85	°C
ILED per LED pin	0 to 150	mA
Total Output Current	0 to 300	mA

NOTE: Typical application circuit with external components is shown above.

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**Table 3. ELECTRICAL OPERATING CHARACTERISTICS**

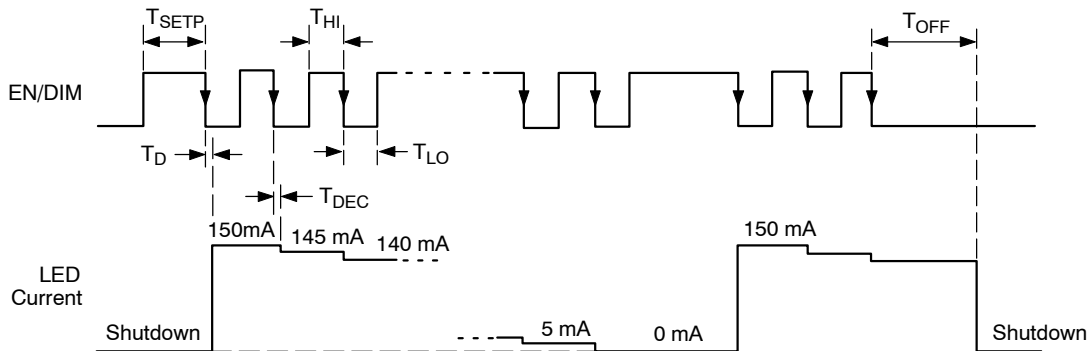
(over recommended operating conditions unless specified otherwise) VIN = 3.6 V, EN = High, ambient temperature of 25°C.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I <sub>Q</sub>	Quiescent Current	1x mode, no load 1.5x mode, no load		0.5 3		mA
I <sub>QSHDN</sub>	Shutdown Current	V <sub>EN</sub> = 0 V			1	μA
I <sub>LED-ACC</sub>	LED Current Accuracy	5 mA ≤ I <sub>LED</sub> ≤ 150 mA		±3		%
I <sub>LED-DEV</sub>	LED Channel Matching	(I <sub>LED</sub> - I <sub>LEDAVG</sub> ) / I <sub>LEDAVG</sub>		±3		%
R <sub>OUT</sub>	Output Resistance (open loop)	1x mode, I <sub>OUT</sub> = 100 mA 1.5x mode, I <sub>OUT</sub> = 100 mA		0.4 2.6		Ω
F <sub>OSC</sub>	Charge Pump Frequency		0.8	1	1.3	MHz
I <sub>SC_MAX</sub>	Output short circuit Current Limit	V <sub>OUT</sub> < 0.5 V		60		mA
I <sub>IN_MAX</sub>	Input Current Limit	1x mode, V <sub>OUT</sub> > 1 V		350		mA
I <sub>EN/DIM</sub> V <sub>HI</sub> V <sub>LO</sub>	EN/DIM Pin - Input Leakage - Logic High Level - Logic Low Level		-1 1.3		1 0.4	μA V V
T <sub>SD</sub>	Thermal Shutdown			165		°C
T <sub>HYS</sub>	Thermal Hysteresis			20		°C
V <sub>UVLO</sub>	Undervoltage lock out (UVLO) Threshold			2		V

**Table 4. RECOMMENDED EN/DIM TIMING**

(For 3 V ≤ VIN ≤ 5.5 V, over full ambient temperature range -40°C to +85°C.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T <sub>SETP</sub>	EN/DIM setup from shutdown		10			μs
T <sub>LO</sub>	EN/DIM program low time		0.3		200	μs
T <sub>HI</sub>	EN/DIM program high time		0.3			μs
T <sub>OFF</sub>	EN/DIM low time to shutdown		1.5			ms
T <sub>D</sub>	LED current enable			40		μs
T <sub>DEC</sub>	LED current decrement			0.1		μs



**Figure 2. LED Dimming Timing Diagram**

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## TYPICAL CHARACTERISTICS

(VIN = 3.6 V, IOUT = 100 mA, CIN = COUT = 2.2 μF, C1 = C2 = 1 μF, TAMB = 25°C unless otherwise specified.)

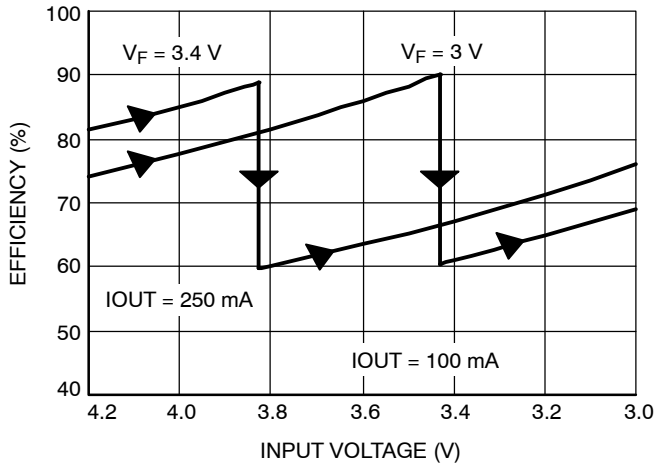


Figure 3. Efficiency vs. Input Voltage

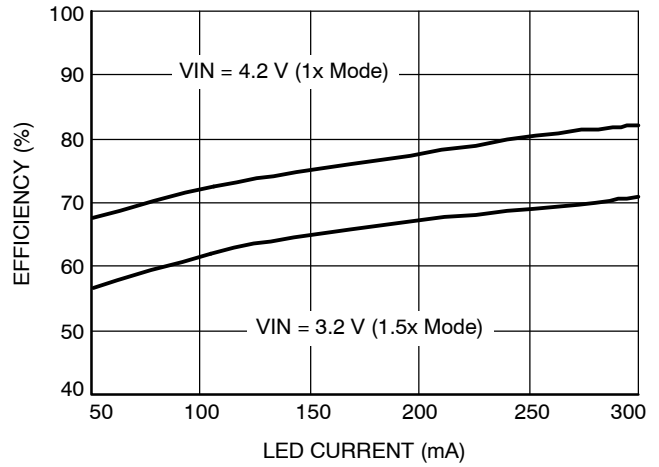


Figure 4. Efficiency vs. LED Current

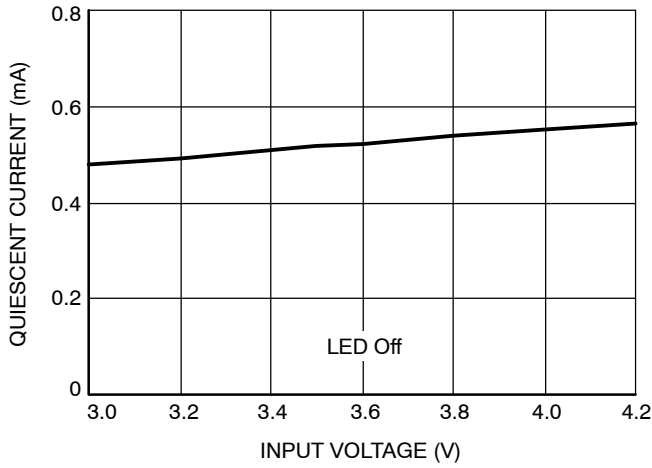


Figure 5. Quiescent Current vs. Input Voltage (1x Mode)

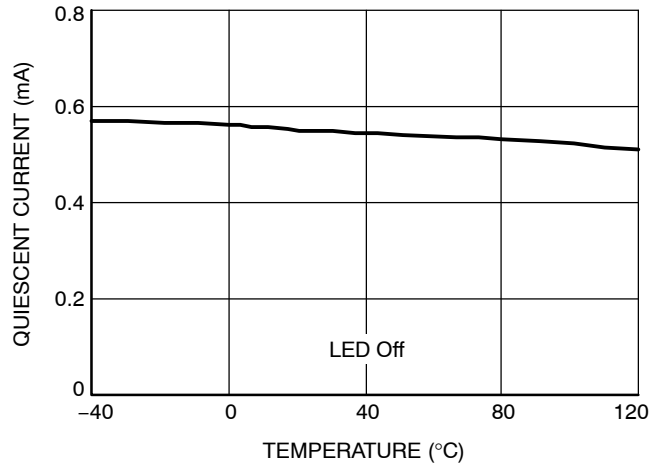


Figure 6. Quiescent Current vs. Temperature (1x Mode)

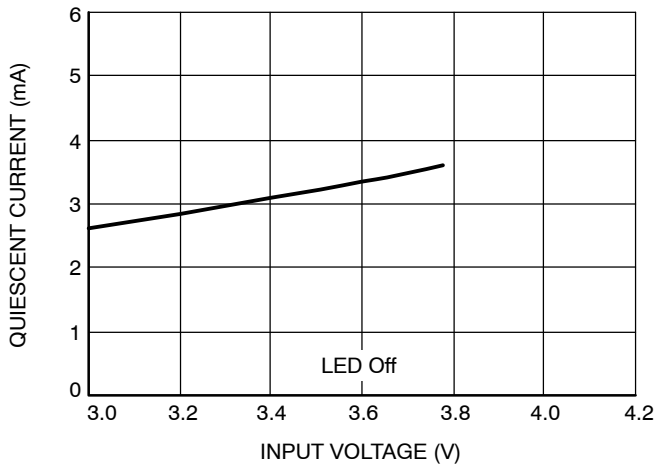


Figure 7. Quiescent Current vs. Input Voltage (1.5x Mode)

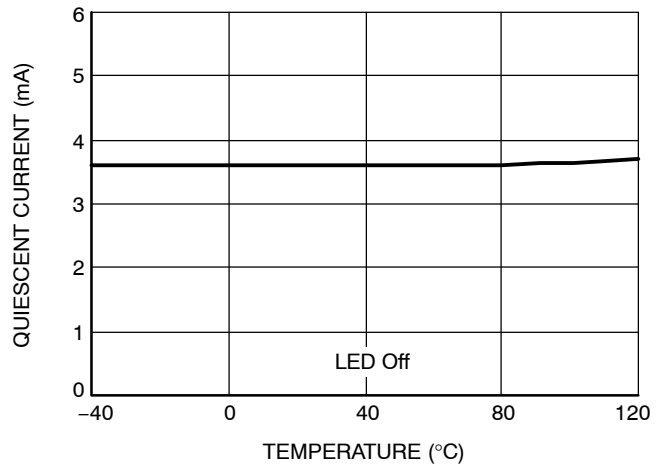
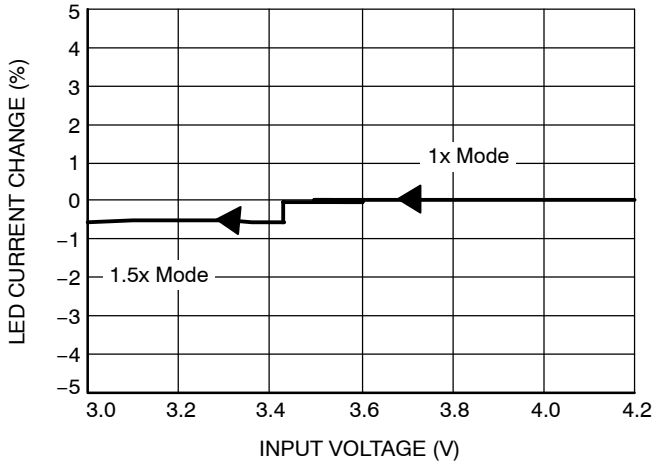


Figure 8. Quiescent Current vs. Temperature (1.5x Mode)

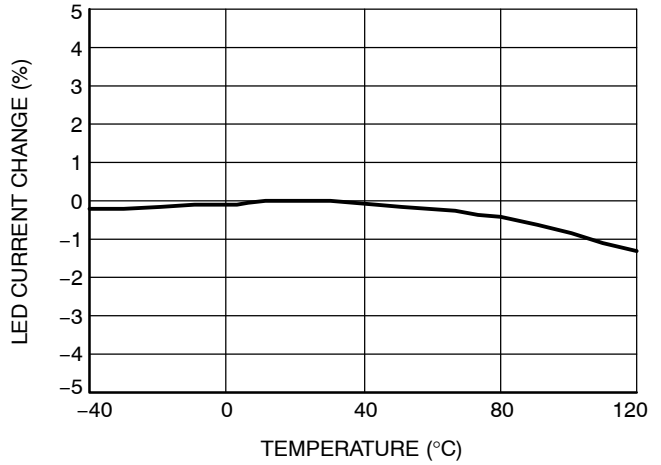
# CAT3612

## TYPICAL CHARACTERISTICS

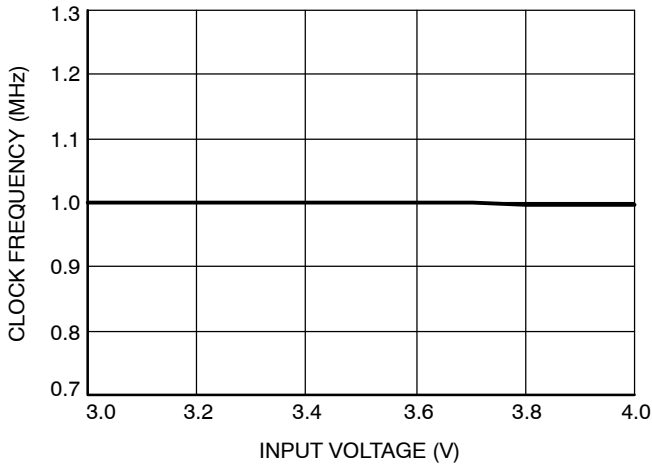
( $V_{IN} = 3.6\text{ V}$ ,  $I_{OUT} = 100\text{ mA}$ ,  $C_{IN} = C_{OUT} = 2.2\text{ }\mu\text{F}$ ,  $C_1 = C_2 = 1\text{ }\mu\text{F}$ ,  $T_{AMB} = 25^\circ\text{C}$  unless otherwise specified.)



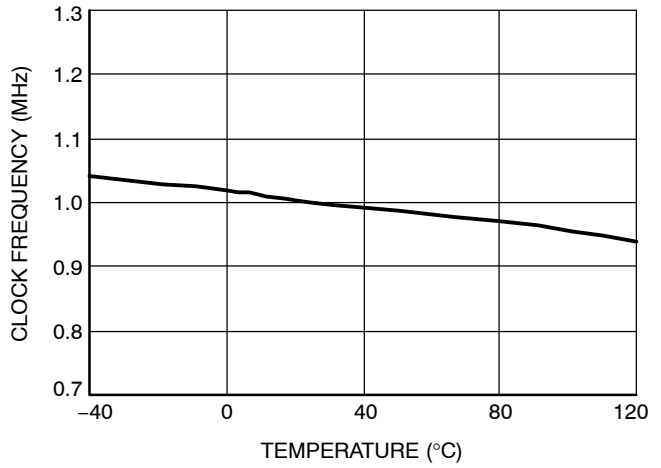
**Figure 9. LED Current Change vs. Input Voltage**



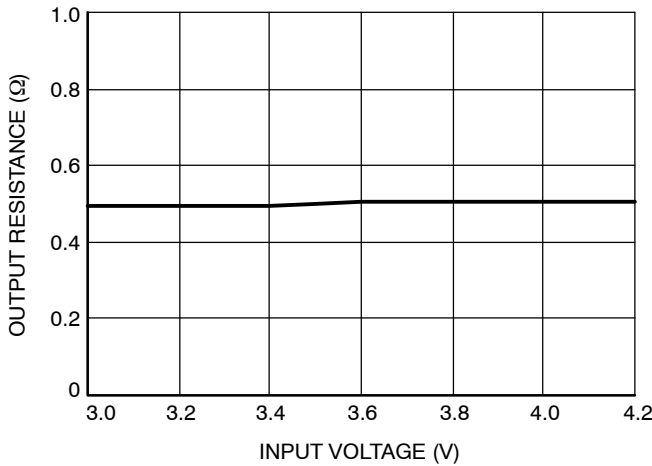
**Figure 10. LED Current Change vs. Temperature**



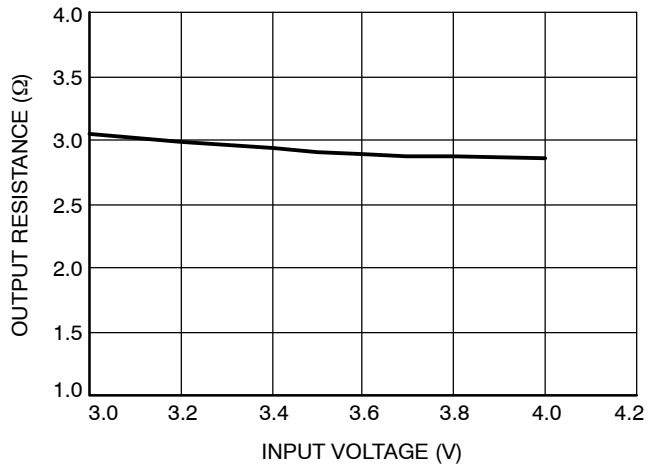
**Figure 11. Oscillator Frequency vs. Input Voltage**



**Figure 12. Oscillator Frequency vs. Temperature**



**Figure 13. Output Resistance vs. Input Voltage (1x Mode)**



**Figure 14. Output Resistance vs. Input Voltage (1.5x Mode)**

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## TYPICAL CHARACTERISTICS

(VIN = 3.6 V, IOUT = 100 mA, CIN = COUT = 2.2 μF, C1 = C2 = 1 μF, TAMB = 25°C unless otherwise specified.)

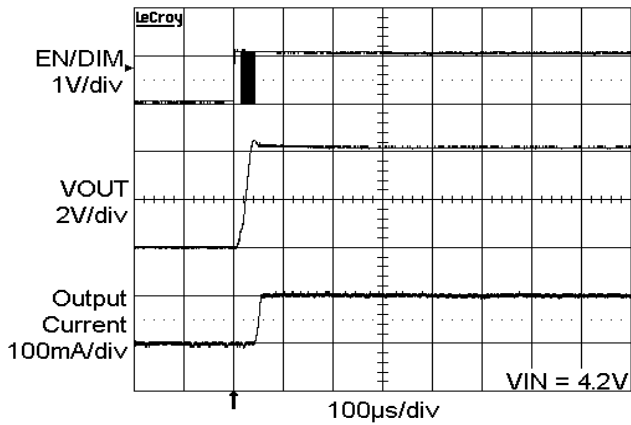


Figure 15. Power Up with 1 LED at 100 mA (1x Mode)

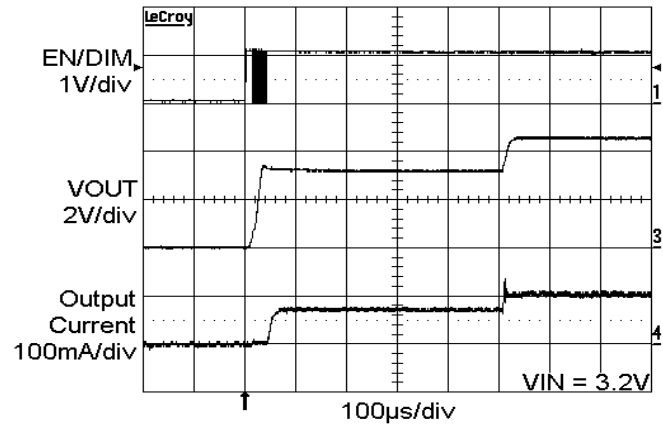


Figure 16. Power Up with 1 LED at 100 mA (1.5x Mode)

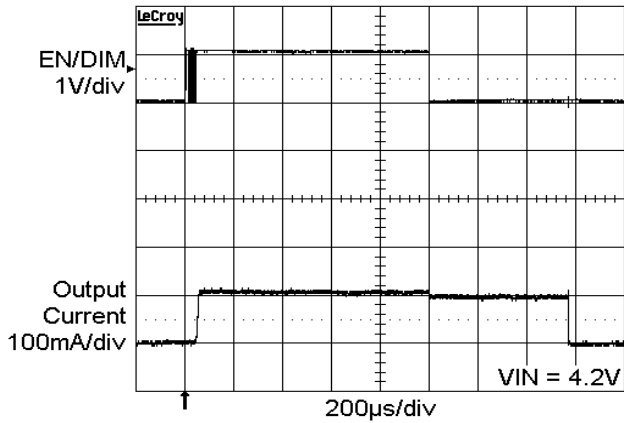


Figure 17. Enable Power Down Delay (1x Mode)

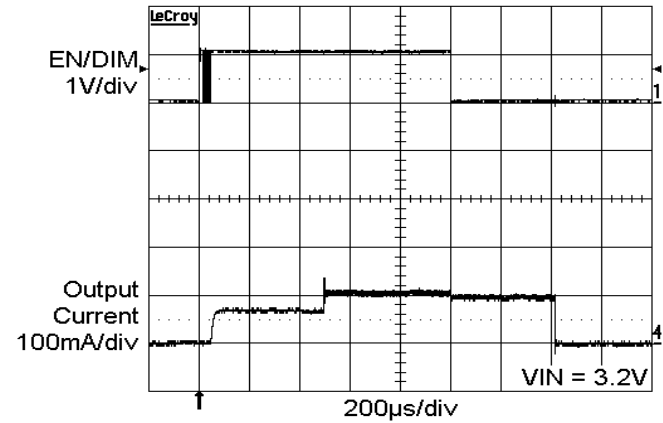


Figure 18. Enable Power Down Delay (1.5x Mode)

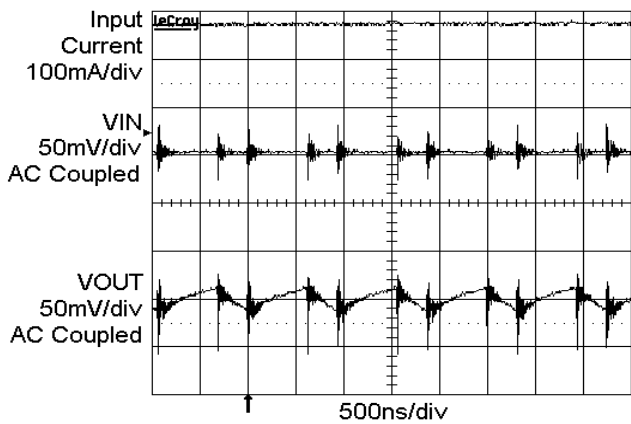


Figure 19. Switching Waveforms in 1.5x Mode

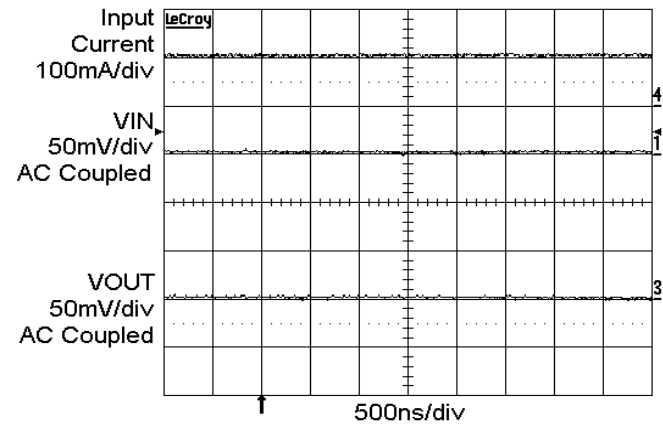


Figure 20. Operating Waveforms in 1x Mode

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## TYPICAL CHARACTERISTICS

(VIN = 3.6 V, IOUT = 100 mA, CIN = COUT = 2.2 μF, C1 = C2 = 1 μF, TAMB = 25°C unless otherwise specified.)

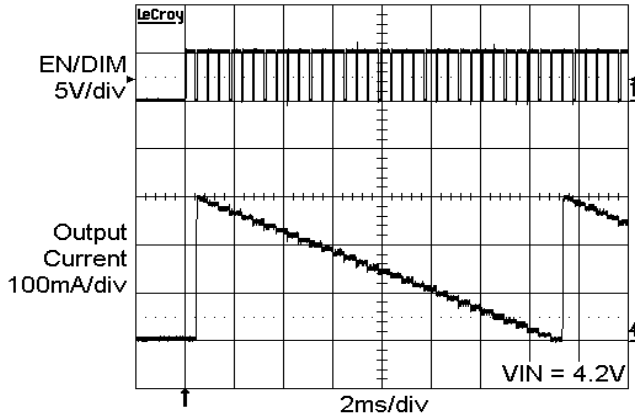


Figure 21. Enable and Output Current Dimming Waveforms

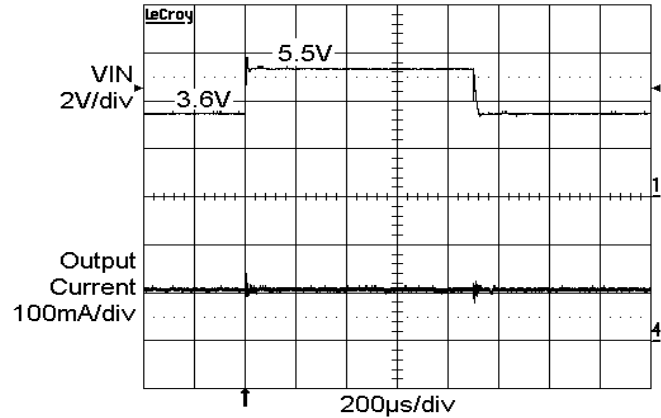


Figure 22. Line Transient Response (3.6 V to 5.5 V) 1x Mode

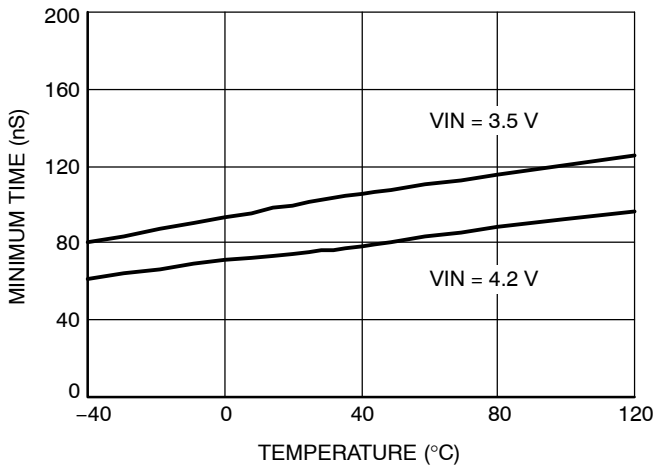


Figure 23. Enable High Minimum Program Time vs. Temperature

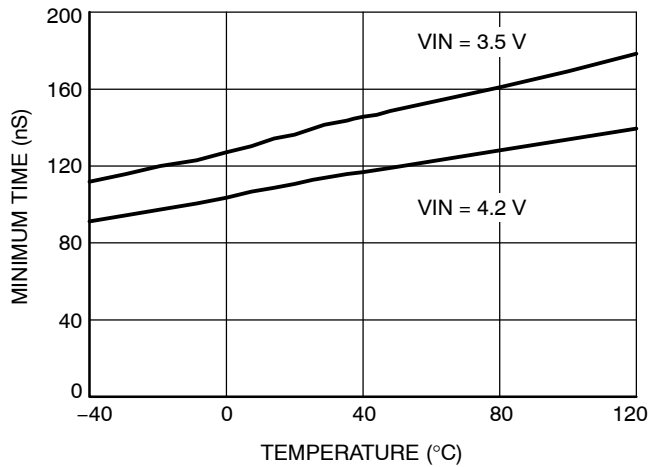


Figure 24. Enable Low Minimum Program Time vs. Temperature

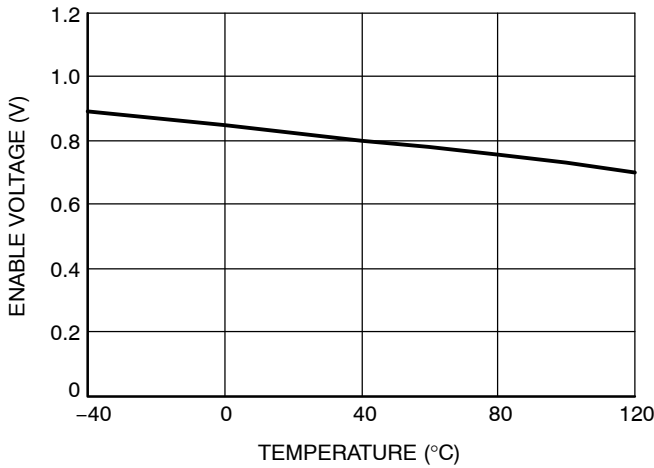


Figure 25. Enable Voltage Threshold vs. Temperature

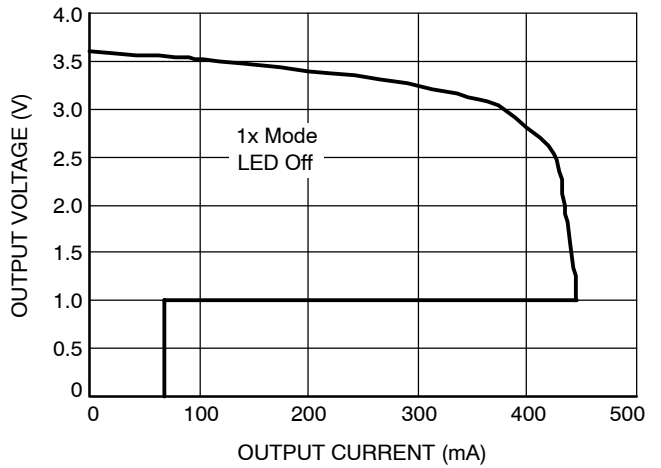


Figure 26. Foldback Current Limit

Table 5. PIN DESCRIPTIONS

Pin #	Name	Function
1	VIN	Supply voltage.
2	C1+	Bucket capacitor 1 terminal
3	C1-	Bucket capacitor 1 terminal
4	C2-	Bucket capacitor 2 terminal
5	GND	Ground reference
6	LED1	LED1 cathode terminal (if not used, connect to VOUT) (Note 3)
7	LED2	LED2 cathode terminal (if not used, connect to VOUT) (Note 3)
8	C2+	Bucket capacitor 2 terminal
9	-	Not connected
10	EN/DIM	Device enable (active high) and dimming control input.
11	-	Not connected
12	VOUT	Charge pump output connected to the LED anodes.
TAB	TAB	Connect to GND on the PCB.

3. LED1, LED2 pins should not be left floating. They should be connected to the LED cathode, or tied to the VOUT pin if not used.

### Pin Function

**VIN** is the supply pin for the device. A small 1  $\mu$ F ceramic bypass capacitor is required between the VIN pin and ground near the device. The operating input voltage range is up to 5.5 V. When the input supply falls below the undervoltage threshold (2 V), all LEDs channels are disabled.

**EN/DIM** is the enable and dimming control logic input for all LED channels. Guaranteed levels of logic high and logic low are set at 1.3 V and 0.4 V respectively. When EN/DIM is initially taken high, the device becomes enabled and the LED currents remain at 0 mA. The falling edge of the first pulse on EN/DIM sets the LED currents to the full scale 150 mA.

On each consecutive falling edge of the pulse on EN/DIM, the LED current decreases by 150/31 mA. On the 32<sup>nd</sup> pulse, the LED current is set to zero. The next pulse on EN/DIM resets the current back to full scale 150 mA.

To place the device into zero current shutdown mode, the EN/DIM pin must be held low for 1.5 ms or more.

**VOUT** is the charge pump output that is connected to the LED anodes. A small 1  $\mu$ F ceramic bypass capacitor is required between the VOUT pin and ground near the device.

**GND** is the ground reference for the charge pump. The pin must be connected to the ground plane on the PCB.

**C1+, C1-** are connected to each side of the 1  $\mu$ F ceramic bucket capacitor C1.

**C2+, C2-** are connected to each side of the 1  $\mu$ F ceramic bucket capacitor C2.

**LED1, LED2** provide the internal regulated current for each of the LED cathodes. These pins enter a high impedance zero current state whenever the device is in shutdown mode. In applications using only one LED channel, the unused channel should be tied directly to VOUT. The disabled channel only draws about 0.5 mA.

**TAB** is the exposed pad underneath the package. For best thermal performance, the tab should be soldered to the PCB and connected to the ground plane.



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## Block Diagram

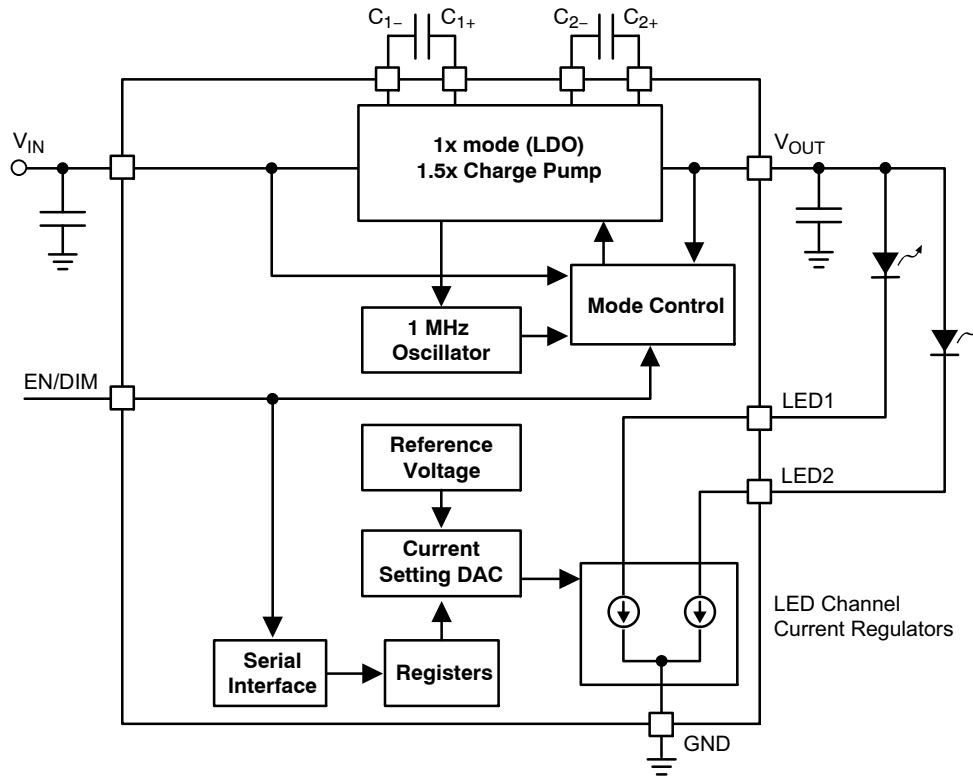


Figure 27. CAT3612 Functional Block Diagram

### Basic Operation

At power-up, the CAT3612 starts operating in 1x mode where the output will be approximately equal to the input supply voltage (less any internal voltage losses). If the output voltage is sufficient to regulate all LEDs currents the device remains in 1x operating mode.

If the input voltage is insufficient or falls to a level where the regulated currents cannot be maintained, the device automatically switches (after a fixed of 400  $\mu$ s) into 1.5x mode.

In 1.5x mode, the output is approximately equal to 1.5 times the input supply voltage (less any internal voltage losses).

The above sequence is repeated each and every time the chip is powered-up or is taken out of shutdown mode (via EN/DIM pin).

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## LED Current Setting

Figure 2 shows the EN/DIM input timing diagram for setting the LED currents. The EN/DIM set-up time requires the signal to be held high for 10  $\mu$ s or longer to ensure the initialization of the driver at power-up. Each subsequent pulse on the EN/DIM (300 ns to 200  $\mu$ s pulse duration) steps down the LED current from full scale of 150 mA to zero with nearly 5 mA resolution. The selection of the LED current per channel is shown in Table 6. Consecutive pulses should be separated by 300 ns or longer. Pulsing beyond the 0 mA level restores the current level back to full scale and the cycle repeats. Pulsing frequencies from 5 kHz up to 1 MHz can be supported during dimming operations. When the EN/DIM is held low for 1.5 ms or more, the CAT3612 enters the shutdown mode and draws “zero” current.

For applications with 2 LEDs, each LED connected to one LED pin, refer to Figure 28.

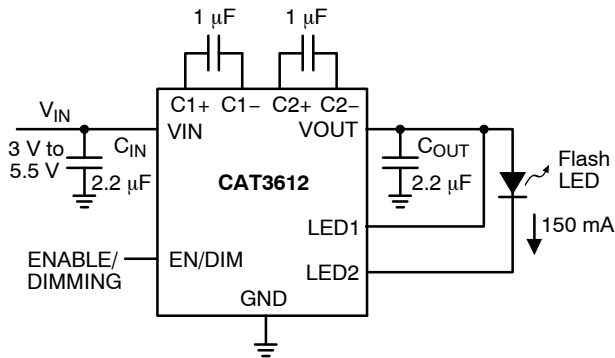


Figure 28. Application with 2 LEDs

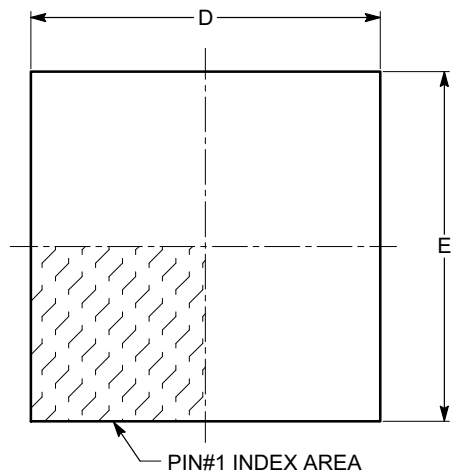
Table 6. SELECTION OF LED CURRENT PER CHANNEL

Number of Pulses on EN/DIM	LED Current (mA)
1	150
2	145
3	140
4	135.5
5	131
6	126
7	121
8	116
9	111
10	106.5
11	101.5
12	97
13	92
14	87
15	82
16	77.5
17	72.5
18	68
19	63
20	58
21	53
22	48.5
23	43.5
24	39
25	34
26	29
27	24
28	19
29	14.5
30	10
31	5
32	0

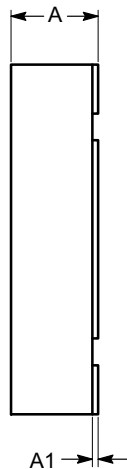


**TDFN12, 3x3**  
**CASE 511AN-01**  
**ISSUE A**

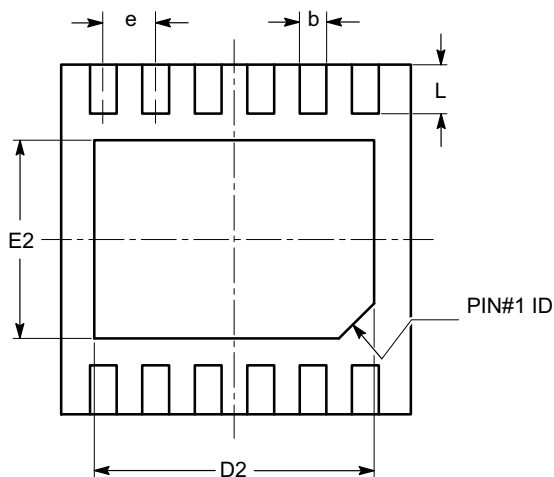
DATE 18 MAR 2009



**TOP VIEW**

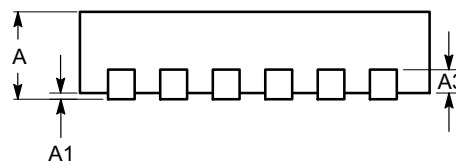


**SIDE VIEW**



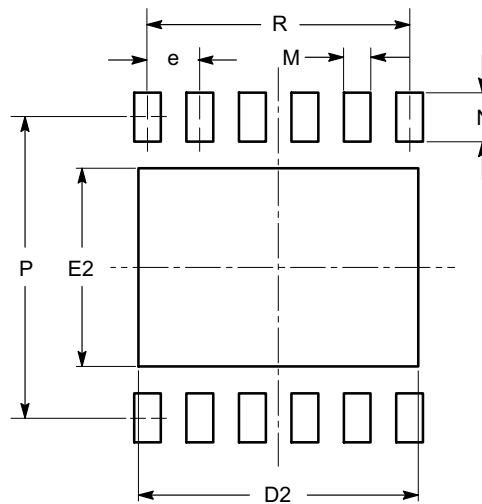
**BOTTOM VIEW**

SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.178	0.203	0.228
b	0.18	0.23	0.30
D	2.90	3.00	3.10
D2	2.30	2.40	2.50
E	2.90	3.00	3.10
E2	1.55	1.70	1.75
e	0.45 BSC		
L	0.30	0.40	0.50
M	0.25	0.30	0.35
N	0.60	0.70	0.80
P	2.70	3.00	3.10
R	2.25 TYP		



**FRONT VIEW**

**RECOMMENDED LAND PATTERN**



**Notes:**

- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MO-229.

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<b>DESCRIPTION:</b>	<b>TDFN12, 3X3</b>	<b>PAGE 1 OF 1</b>

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